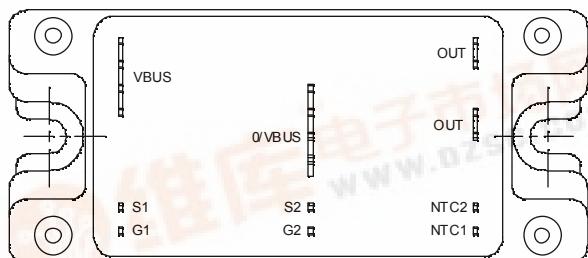
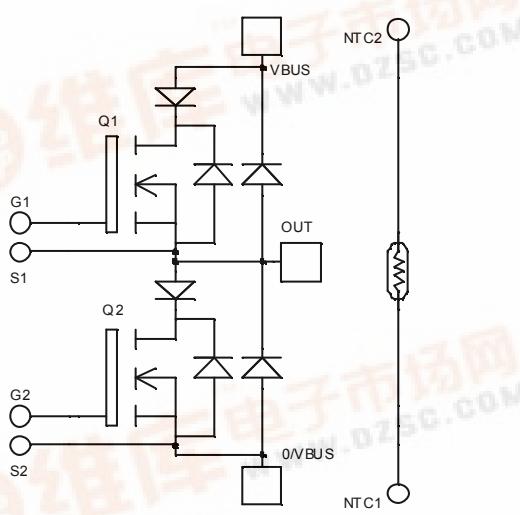




APTC80A15SCTG

*Phase leg
Serie & SiC parallel diodes
Super Junction
MOSFET Power Module*



Absolute maximum ratings

| Symbol | Parameter | Max ratings | Unit |
|------------|---|--------------------------|------------------|
| V_{DSS} | Drain - Source Breakdown Voltage | 800 | V |
| I_D | Continuous Drain Current | $T_c = 25^\circ\text{C}$ | A |
| | | $T_c = 80^\circ\text{C}$ | |
| I_{DM} | Pulsed Drain current | 112 | |
| V_{GS} | Gate - Source Voltage | ± 30 | V |
| R_{DSon} | Drain - Source ON Resistance | 150 | $\text{m}\Omega$ |
| P_D | Maximum Power Dissipation | $T_c = 25^\circ\text{C}$ | W |
| I_{AR} | Avalanche current (repetitive and non repetitive) | 17 | A |
| E_{AR} | Repetitive Avalanche Energy | 0.5 | mJ |
| E_{AS} | Single Pulse Avalanche Energy | 670 | |

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handing Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

| Symbol | Characteristic | Test Conditions | | Min | Typ | Max | Unit |
|--------------|---------------------------------|---|---------------------------|-----|-----|-----------|------------------|
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{GS} = 0\text{V}$, $V_{DS} = 800\text{V}$ | $T_j = 25^\circ\text{C}$ | | | 50 | μA |
| | | $V_{GS} = 0\text{V}$, $V_{DS} = 800\text{V}$ | $T_j = 125^\circ\text{C}$ | | | 375 | |
| $R_{DS(on)}$ | Drain – Source on Resistance | $V_{GS} = 10\text{V}$, $I_D = 14\text{A}$ | | | | 150 | $\text{m}\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS} = V_{DS}$, $I_D = 2\text{mA}$ | | 2.1 | 3 | 3.9 | V |
| I_{GSS} | Gate – Source Leakage Current | $V_{GS} = \pm 20\text{ V}$, $V_{DS} = 0\text{V}$ | | | | ± 150 | nA |

Dynamic Characteristics

| Symbol | Characteristic | Test Conditions | | Min | Typ | Max | Unit |
|--------------|------------------------------|---|---|-----|------|-----|---------------|
| C_{iss} | Input Capacitance | $V_{GS} = 0\text{V}$ $V_{DS} = 25\text{V}$ $f = 1\text{MHz}$ | | | 4507 | | pF |
| C_{oss} | Output Capacitance | | | | 2092 | | |
| C_{rss} | Reverse Transfer Capacitance | | | | 108 | | |
| Q_g | Total gate Charge | $V_{GS} = 10\text{V}$ $V_{Bus} = 400\text{V}$ $I_D = 28\text{A}$ | | | 180 | | nC |
| Q_{gs} | Gate – Source Charge | | | | 22 | | |
| Q_{gd} | Gate – Drain Charge | | | | 90 | | |
| $T_{d(on)}$ | Turn-on Delay Time | Inductive switching @ 125°C $V_{GS} = 15\text{V}$ $V_{Bus} = 533\text{V}$ $I_D = 28\text{A}$ $R_G = 2.5\Omega$ | | | 10 | | ns |
| T_r | Rise Time | | | | 13 | | |
| $T_{d(off)}$ | Turn-off Delay Time | | | | 83 | | |
| T_f | Fall Time | | | | 35 | | |
| E_{on} | Turn-on Switching Energy | Inductive switching @ 25°C $V_{GS} = 15\text{V}$, $V_{Bus} = 533\text{V}$ $I_D = 28\text{A}$, $R_G = 2.5\Omega$ | | | 291 | | μJ |
| E_{off} | Turn-off Switching Energy | | | | 278 | | |
| E_{on} | Turn-on Switching Energy | | Inductive switching @ 125°C $V_{GS} = 15\text{V}$, $V_{Bus} = 533\text{V}$ $I_D = 28\text{A}$, $R_G = 2.5\Omega$ | | 510 | | μJ |
| E_{off} | Turn-off Switching Energy | | | | 342 | | |

Series diode ratings and characteristics

| Symbol | Characteristic | Test Conditions | | Min | Typ | Max | Unit | |
|-----------|---|--|---------------------------|-----|-----|------|---------------|--|
| V_{RRM} | Maximum Peak Repetitive Reverse Voltage | $V_R = 200\text{V}$ | | 200 | | | V | |
| I_{RM} | Maximum Reverse Leakage Current | | $T_j = 25^\circ\text{C}$ | | | 250 | μA | |
| I_F | DC Forward Current | | $T_c = 85^\circ\text{C}$ | | 30 | | A | |
| V_F | Diode Forward Voltage | $I_F = 30\text{A}$ | | | 1.1 | 1.15 | V | |
| | | $I_F = 60\text{A}$ | | | 1.4 | | | |
| | | $I_F = 30\text{A}$ | $T_j = 125^\circ\text{C}$ | | 0.9 | | | |
| t_{rr} | Reverse Recovery Time | $I_F = 30\text{A}$ $V_R = 133\text{V}$ $di/dt = 200\text{A}/\mu\text{s}$ | $T_j = 25^\circ\text{C}$ | | 24 | | ns | |
| | | | $T_j = 125^\circ\text{C}$ | | 48 | | | |
| Q_{rr} | Reverse Recovery Charge | | $T_j = 25^\circ\text{C}$ | | 33 | | nC | |
| | | | $T_j = 125^\circ\text{C}$ | | 150 | | | |

Parallel diode ratings and characteristics

| Symbol | Characteristic | Test Conditions | Min | Typ | Max | Unit |
|------------------|---|---|------------------------|-----|------|------|
| V _{RRM} | Maximum Peak Repetitive Reverse Voltage | | 1200 | | | V |
| I _{RM} | Maximum Reverse Leakage Current | V _R =1200V | T _j = 25°C | 150 | 600 | μA |
| | | | T _j = 175°C | 300 | 3000 | |
| I _F | DC Forward Current | | T _c = 125°C | 15 | | A |
| V _F | Diode Forward Voltage | I _F = 15A | T _j = 25°C | 1.6 | 1.8 | V |
| | | | T _j = 175°C | 2.6 | 3.0 | |
| Q _C | Total Capacitive Charge | I _F = 15A, V _R = 600V di/dt=1000A/μs | | 42 | | nC |
| Q | Total Capacitance | f = 1MHz, V _R = 200V | | 135 | | pF |
| | | f = 1MHz, V _R = 400V | | 99 | | |

Thermal and package characteristics

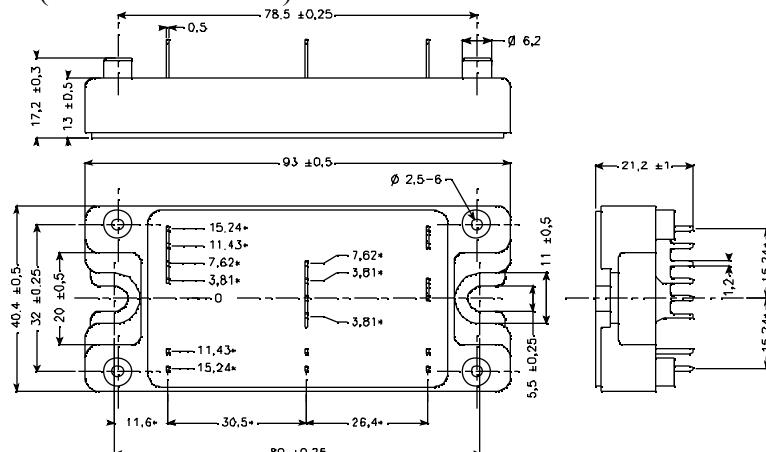
| Symbol | Characteristic | | Min | Typ | Max | Unit |
|-------------------|---|----------------|-----|-----|------|------|
| R _{thJC} | Junction to Case Thermal Resistance | Transistor | | | 0.45 | °C/W |
| | | Series diode | | | 1.2 | |
| | | Parallel diode | | | 1.0 | |
| V _{ISOL} | RMS Isolation Voltage, any terminal to case t =1 min, I isol<1mA, 50/60Hz | 2500 | | | | V |
| T _J | Operating junction temperature range | -40 | | 150 | | °C |
| T _{STG} | Storage Temperature Range | -40 | | 125 | | |
| T _C | Operating Case Temperature | -40 | | 100 | | |
| Torque | Mounting torque | To Heatsink | M5 | 2.5 | 4.7 | N.m |
| Wt | Package Weight | | | | 160 | g |

Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

| Symbol | Characteristic | Min | Typ | Max | Unit |
|--------------------|----------------------------|-----|------|-----|------|
| R ₂₅ | Resistance @ 25°C | | 50 | | kΩ |
| B _{25/85} | T ₂₅ = 298.15 K | | 3952 | | K |

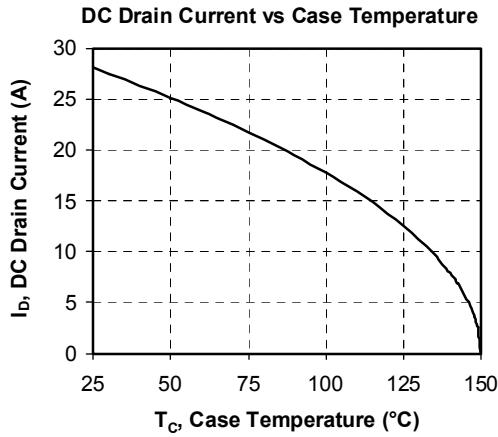
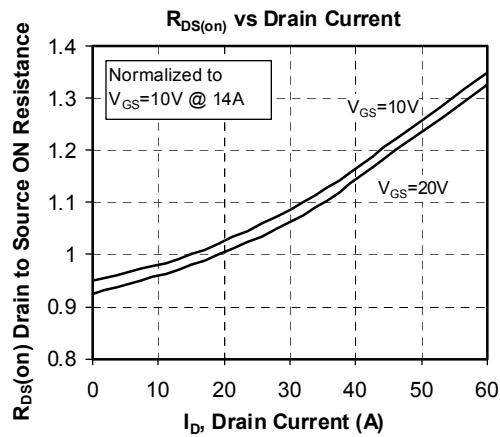
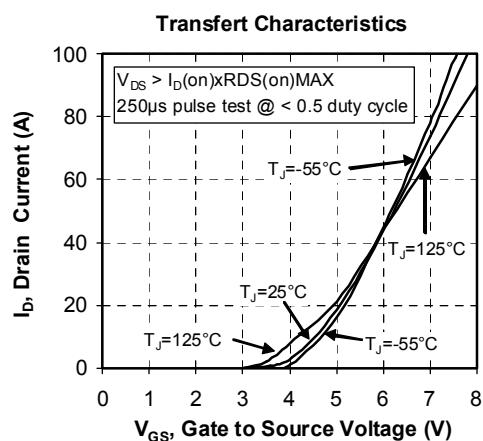
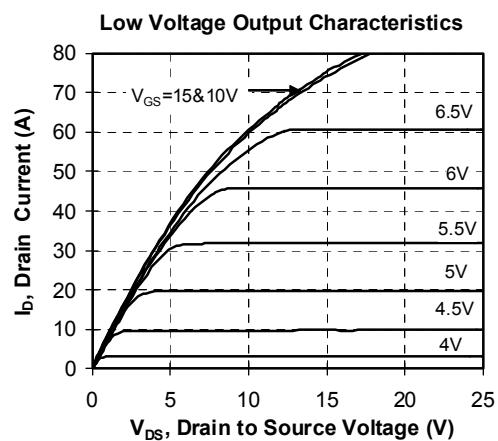
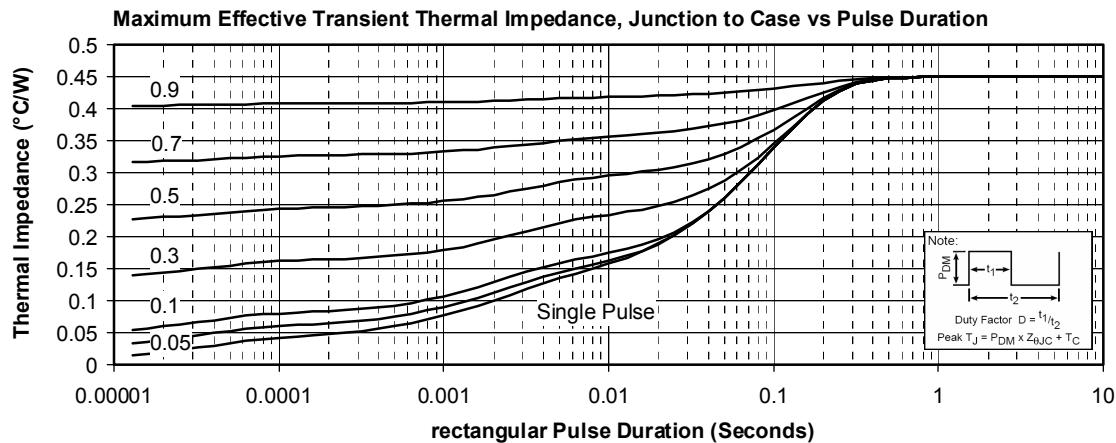
$$R_T = \frac{R_{25}}{\exp[B_{25/85} \left(\frac{1}{T_{25}} - \frac{1}{T} \right)]}$$

T: Thermistor temperature
R_T: Thermistor value at T

SP4 Package outline (dimensions in mm)

 ALL DIMENSIONS MARKED *** ARE TOLERANCED AS: 

See application note APT0501 - Mounting Instructions for SP4 Power Modules on www.microsemi.com

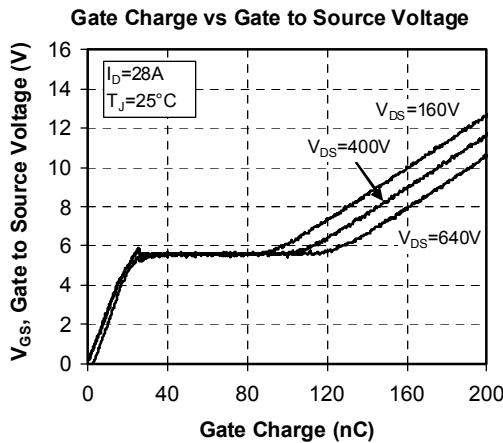
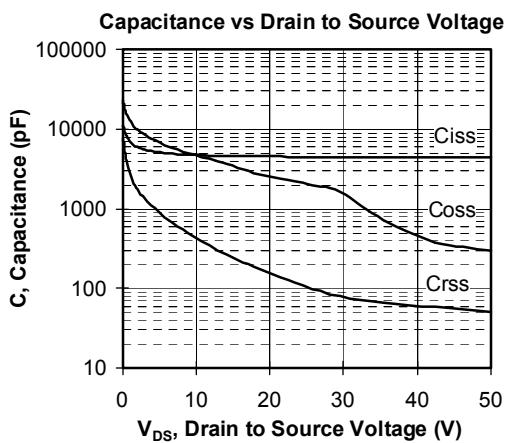
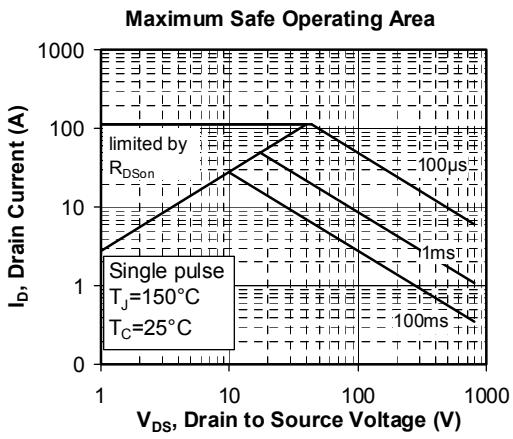
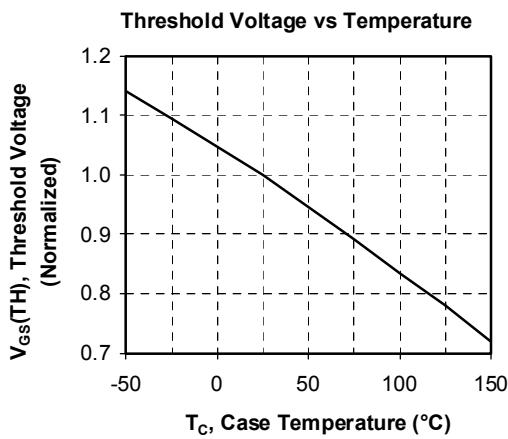
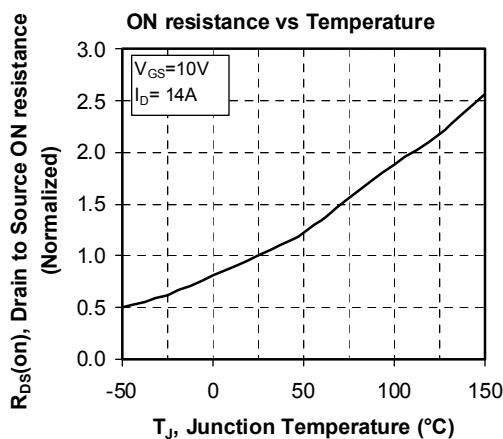
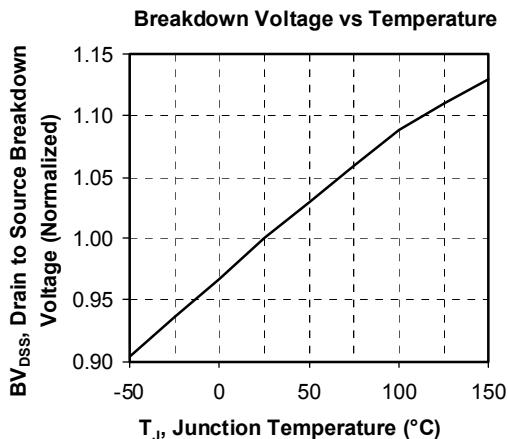
Typical CoolMOS Performance Curve





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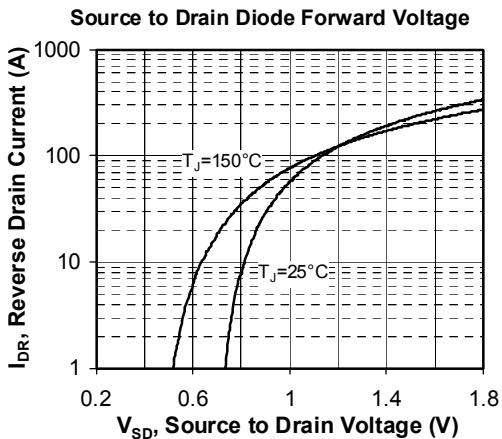
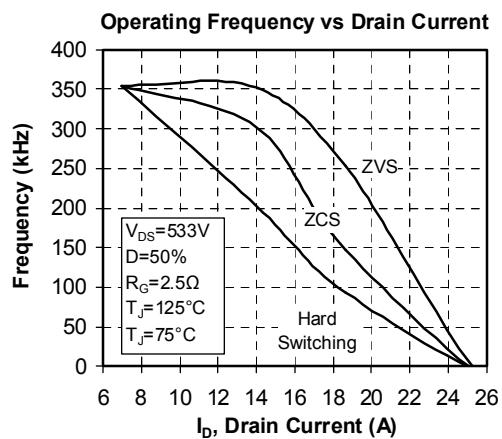
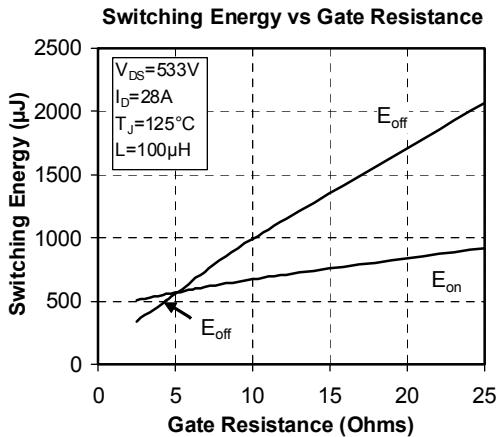
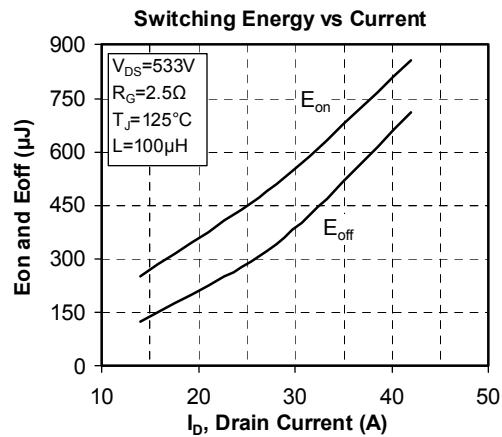
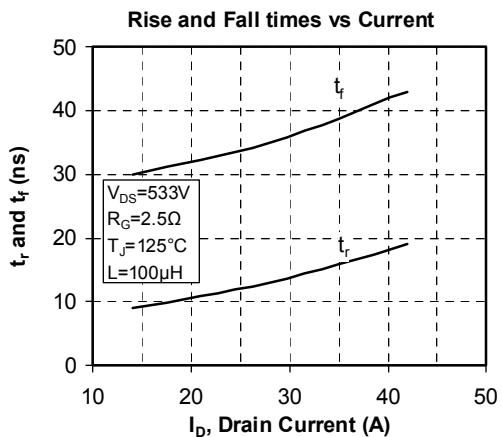
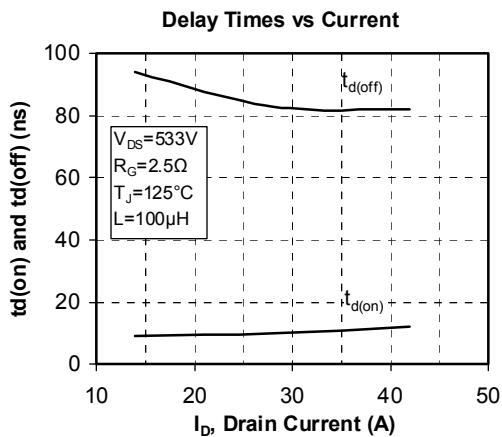
APTC80A15SCTG



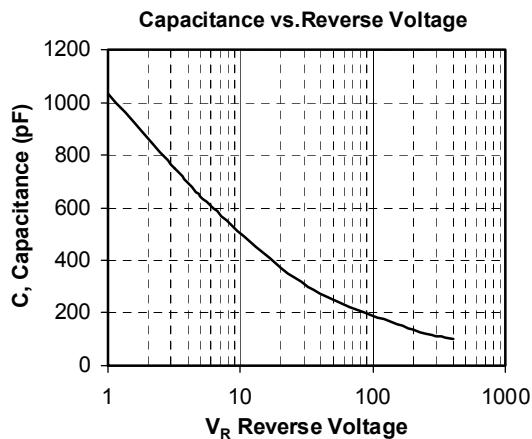
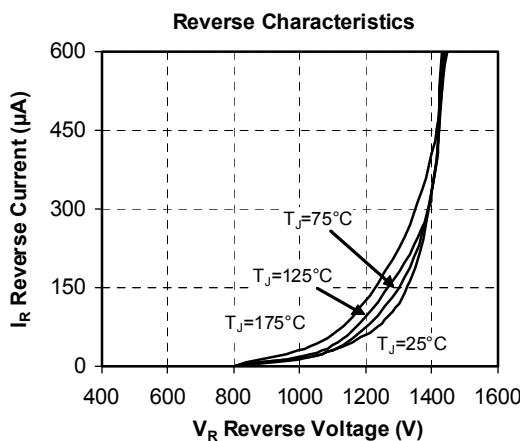
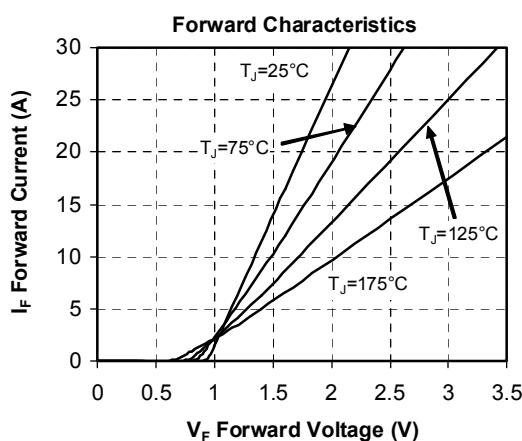
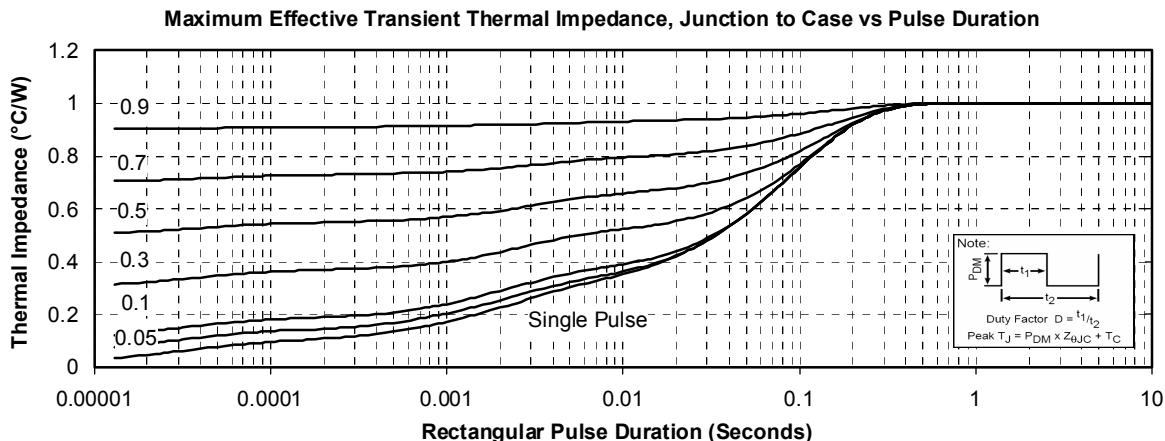


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Typical SiC Diode Performance Curve



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